

# TIPL791, TIPL791A

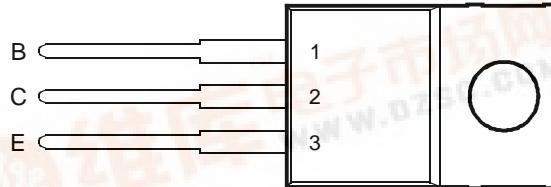
## NPN SILICON POWER TRANSISTORS

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- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability

TO-220 PACKAGE (TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRACA

### absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	TIPL791 TIPL791A	$V_{CBO}$	850 1000	V
Collector-emitter voltage ( $V_{BE} = 0$ )	TIPL791 TIPL791A	$V_{CES}$	850 1000	V
Collector-emitter voltage ( $I_B = 0$ )	TIPL791 TIPL791A	$V_{CEO}$	400 450	V
Emitter-base voltage		$V_{EBO}$	10	V
Continuous collector current		$I_C$	4	A
Peak collector current (see Note 1)		$I_{CM}$	8	A
Continuous device dissipation at (or below) 25°C case temperature		$P_{tot}$	75	W
Operating junction temperature range		$T_j$	-65 to +150	°C
Storage temperature range		$T_{stg}$	-65 to +150	°C

NOTE 1: This value applies for  $t_p \leq 10$  ms, duty cycle  $\leq 2\%$ .

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## electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	TIPL791 TIPL791A	400 450		V
$I_{CES}$ Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$ $V_{CE} = 1000 \text{ V}$ $V_{CE} = 850 \text{ V}$ $V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$		TIPL791 TIPL791A TIPL791 TIPL791A		5 5 200 200	$\mu\text{A}$
$I_{CEO}$ Collector cut-off current	$V_{CE} = 400 \text{ V}$ $V_{CE} = 450 \text{ V}$	$I_B = 0$ $I_B = 0$		TIPL791 TIPL791A		5 5	$\mu\text{A}$
$I_{EBO}$ Emitter cut-off current	$V_{EB} = 10 \text{ V}$	$I_C = 0$				1	mA
$h_{FE}$ Forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 3 and 4)		20	60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_B = 1 \text{ A}$ $I_B = 1 \text{ A}$	$I_C = 1 \text{ A}$ $I_C = 2.5 \text{ A}$ $I_C = 4 \text{ A}$ $I_C = 4 \text{ A}$	(see Notes 3 and 4)			0.5 1.0 2.5 5.0	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_B = 1 \text{ A}$ $I_B = 1 \text{ A}$	$I_C = 1 \text{ A}$ $I_C = 2.5 \text{ A}$ $I_C = 4 \text{ A}$ $I_C = 4 \text{ A}$	(see Notes 3 and 4)			1.0 1.2 1.4 1.3	V
$f_t$ Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$			12	MHz
$C_{ob}$ Output capacitance	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 0.1 \text{ MHz}$			110	pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

## thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.66	$^{\circ}\text{C/W}$

## inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

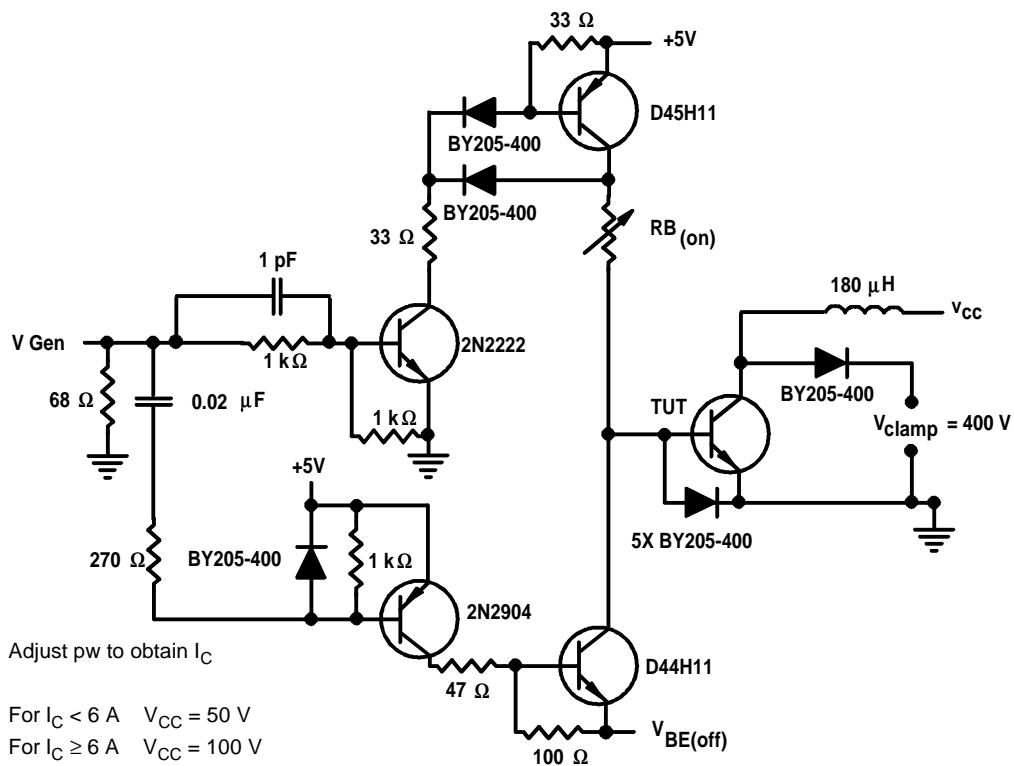
PARAMETER	TEST CONDITIONS <sup>†</sup>			MIN	TYP	MAX	UNIT
$t_{sv}$ Voltage storage time	$I_C = 4 \text{ A}$	$I_{B(on)} = 0.8 \text{ A}$	(see Figures 1 and 2)			2	$\mu\text{s}$
$t_{rv}$ Voltage rise time						200	ns
$t_{fi}$ Current fall time						100	ns
$t_{ti}$ Current tail time						50	ns
$t_{xo}$ Cross over time						200	ns
$t_{sv}$ Voltage storage time	$I_C = 4 \text{ A}$	$I_{B(on)} = 0.8 \text{ A}$	(see Figures 1 and 2)			2.5	$\mu\text{s}$
$t_{rv}$ Voltage rise time						400	ns
$t_{fi}$ Current fall time						200	ns
$t_{ti}$ Current tail time						50	ns
$t_{xo}$ Cross over time						600	ns

<sup>†</sup> Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

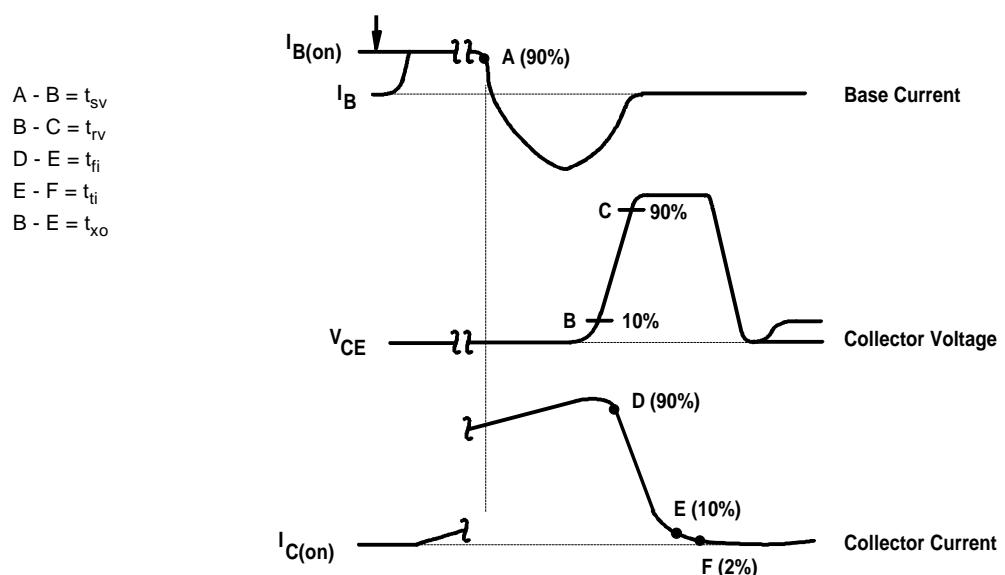
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## PARAMETER MEASUREMENT INFORMATION



**Figure 1. Inductive-Load Switching Test Circuit**



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics:  $t_r < 15 \text{ ns}$ ,  $R_{in} > 10 \Omega$ ,  $C_{in} < 11.5 \text{ pF}$ .  
B. Resistors must be noninductive types.

**Figure 2. Inductive-Load Switching Waveforms**

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## TYPICAL CHARACTERISTICS

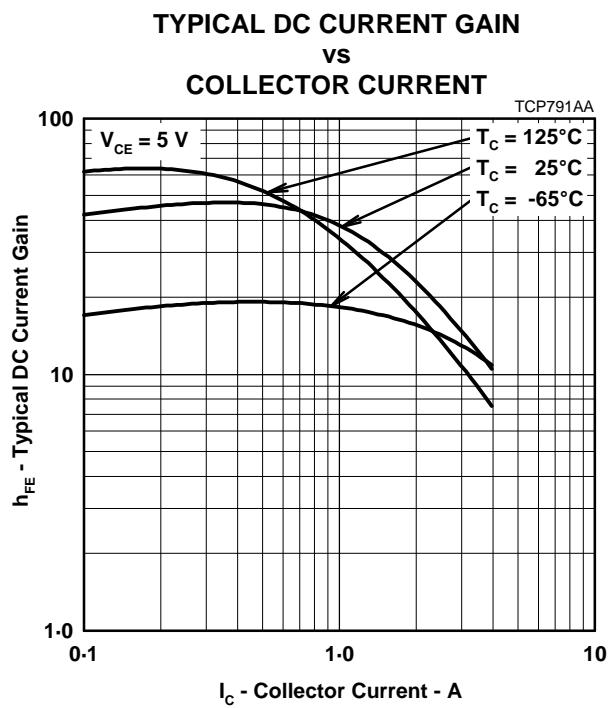


Figure 3.

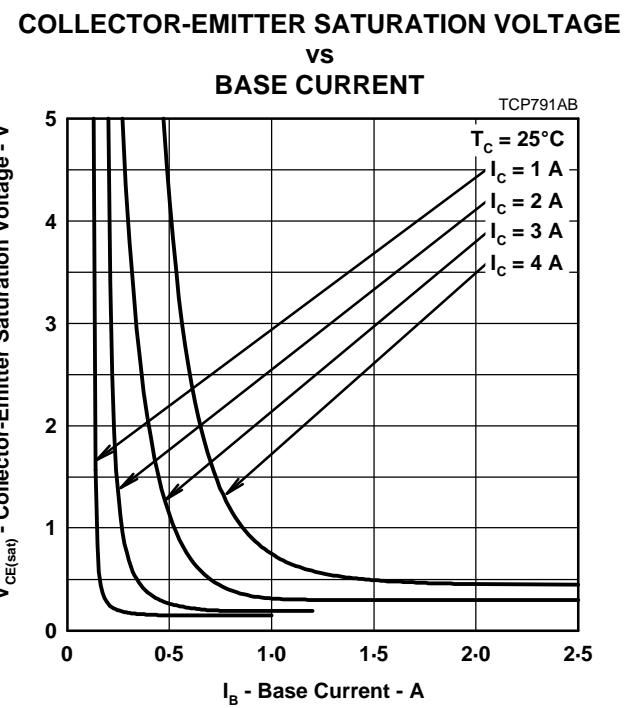


Figure 4.

## MAXIMUM SAFE OPERATING REGIONS

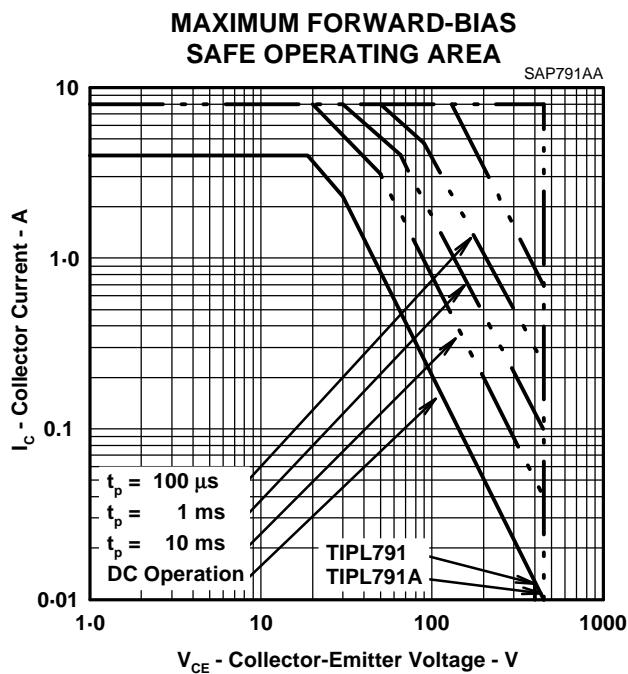


Figure 5.

## THERMAL INFORMATION

### THERMAL RESPONSE JUNCTION TO CASE

#### vs POWER PULSE DURATION

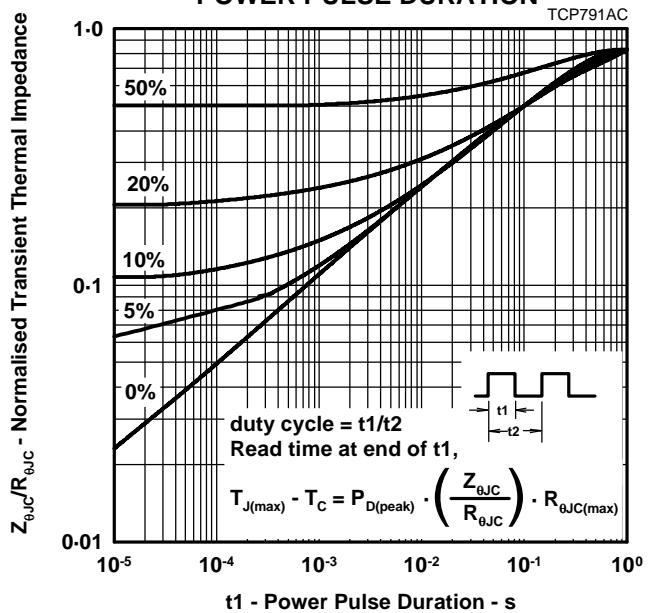


Figure 6.

# TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

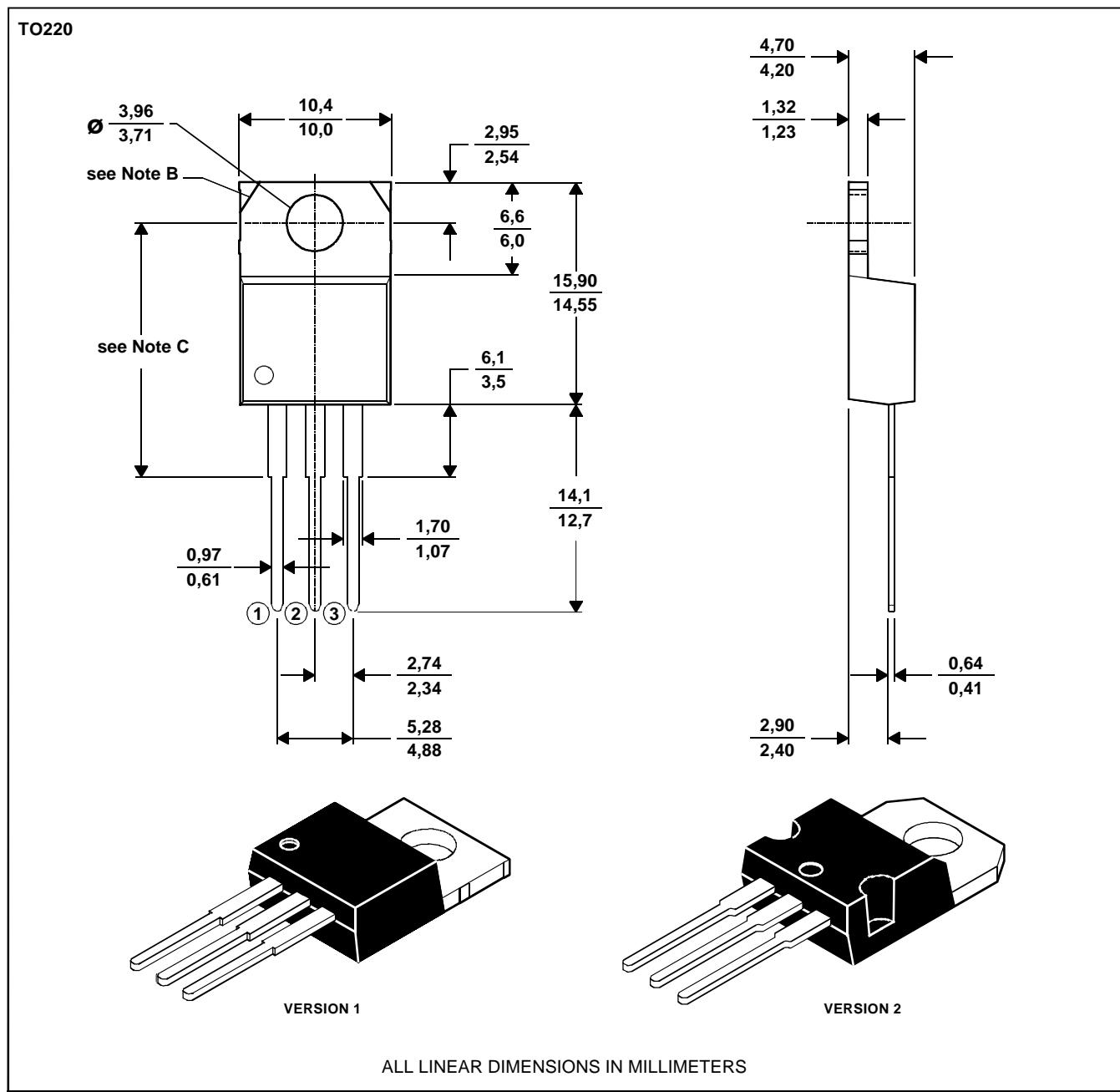
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## MECHANICAL DATA

### TO-220

#### 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

MDXXBE

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

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